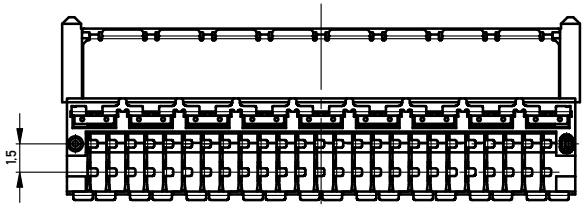
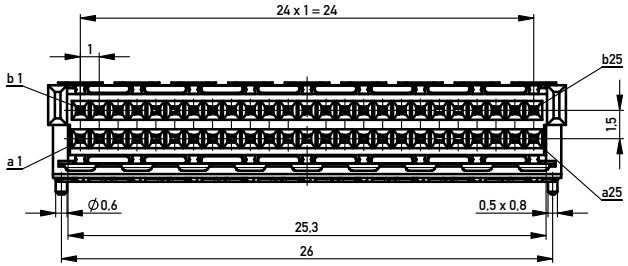
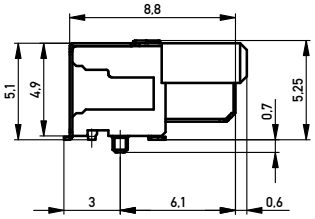
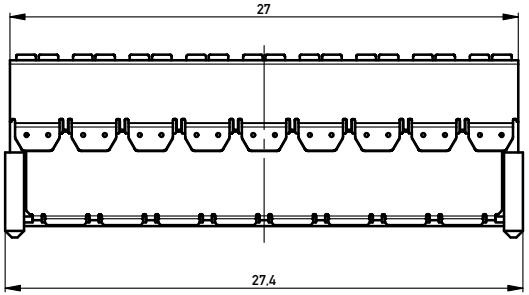
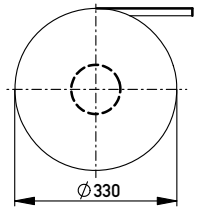




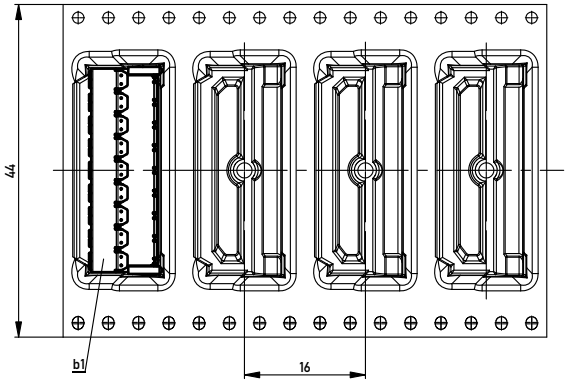




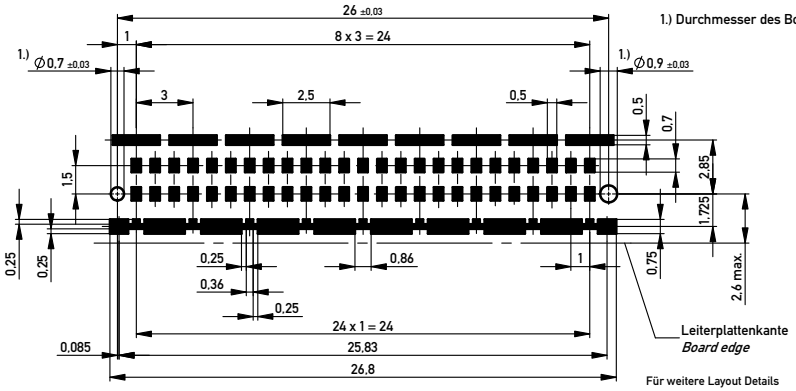
Verpackt in Gurtverpackung
Tape on Reel Packaging
Verpackungseinheit: 500 Stück
Packaging unit: 500 pcs



Abspulrichtung - *Reel off Direction*



Leiterplatten-Layout Vorschlag / *PCB-Layout Proposal*



1.) Durchmesser des Bohrers / *Drill tool*

Für weitere Layout Details bitte Applikations Schrift MicroSpeed beachten.
For further layout details please consider MicroSpeed application note.

Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Information:	Tolerances	All Dimensions in mm	Scale 5:1
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f 20.03.2013 / Index Date			284310 — I — A2
			Class MSPEED

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